1. Designations of the edge mount connectors shall be P1 & P2.
2. Designations of the right angle through hole connectors LS2-130... is J1, LS2-110 is J2, shall be mounted on the top side of the pcb.
3. All test points and identification markings shall be on the bottom side of the pcb.
4. For the purpose of contract automated assembly the board shall have 3 fiducials along sides and bottom of the board.
5. To maintain interboard separation the maximum component height for the top of the board is 0.500 inches and .180 inches for the bottom.
6. The .089 dia holes are for the retention pin on the card guide to pass through.
7. Maintain component keepout area on both sides of board along card edges.